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March 2015

## **FDD6030L**

## 30V N-Channel PowerTrench<sup>o</sup> MOSFET

#### **General Description**

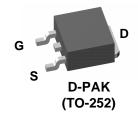
This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on state resistance and yet maintain low gate charge for superior switching performance.

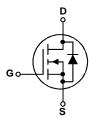
#### **Applications**

- DC/DC converter
- Motor Drives

#### **Features**

- 12 A, 30 V  $R_{DS(ON)} = 14.5 \ m\Omega \ @ \ V_{GS} = 10 \ V$   $R_{DS(ON)} = 21 \ m\Omega \ @ \ V_{GS} = 4.5 \ V$
- · Low gate charge
- Fast Switching Speed
- High performance trench technology for extremely low  $R_{\mbox{\scriptsize DS(ON)}}$





Absolute Maximum Ratings T<sub>A</sub>=25°C unless otherwise noted

Symbol	Para	meter		Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage			30	V
V <sub>GSS</sub>	Gate-Source Voltage			±20	V
I <sub>D</sub>	Continuous Drain Current	@T <sub>C</sub> =25°C	(Note 3)	50	А
		@T <sub>A</sub> =25°C	(Note 1a)	12	
		Pulsed	(Note 1a)	100	
P <sub>D</sub>	Power Dissipation	@T <sub>C</sub> =25°C	(Note 3)	56	W
		@T <sub>A</sub> =25°C	(Note 1a)	3.2	
		@T <sub>A</sub> =25°C	(Note 1b)	1.5	
$T_J, T_{STG}$	Operating and Storage Ju	nction Tempera	ture Range	-55 to +175	°C

#### **Thermal Characteristics**

$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	2.7	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	45	
$R_{\theta JA}$		(Note 1b)	96	

**Package Marking and Ordering Information** 

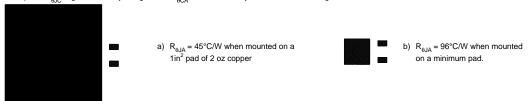
			,				
	Device Marking	Device	Package	Reel Size	Tape width	Quantity	
	FDD6030L	FDD6030L	D-PAK (TO-252)	13"	16mm	2500 units	

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Drain-So	urce Avalanche Ratings (Note	2)				
E <sub>AS</sub>	Drain-Source Avalanche Energy	Single Pulse, V <sub>DD</sub> = 15 V, I <sub>D</sub> = 12A			100	mJ
I <sub>AS</sub>	Drain-Source Avalanche Current				12	Α
Off Char	acteristics			•	•	•
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \qquad I_{D} = 250 \mu\text{A}$	30			V
ΔBV <sub>DSS</sub> ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 250 μA,Referenced to 25°C		24		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 24 V, V <sub>GS</sub> = 0 V			1	μА
I <sub>GSS</sub>	Gate-Body Leakage	$V_{GS} = \pm 20 \text{ V},  V_{DS} = 0 \text{ V}$			±100	nA
On Char	acteristics (Note 2)		•			
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	1	1.9	3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	I <sub>D</sub> = 250 μA,Referenced to 25°C		-5		mV/°C
R <sub>DS(on)</sub>	Static Drain–Source On–Resistance	$V_{GS} = 10 \text{ V},  I_D = 12 \text{ A}$ $V_{GS} = 4.5 \text{ V},  I_D = 10 \text{ A}$ $V_{GS} = 10 \text{ V},  I_D = 12 \text{ A}, T_J = 125^{\circ}\text{C}$		7.7 9.9 11.4	14.5 21 25	mΩ
I <sub>D(on)</sub>	On-State Drain Current	$V_{GS} = 10 \text{ V},  V_{DS} = 5 \text{ V}$	50			Α
g <sub>FS</sub>	Forward Transconductance	$V_{DS} = 10 \text{ V}, \qquad I_{D} = 12 \text{ A}$		47		S
Dynamic	Characteristics					
C <sub>iss</sub>	Input Capacitance			1230		pF
C <sub>oss</sub>	Output Capacitance	$V_{DS} = 15 \text{ V},  V_{GS} = 0 \text{ V},$		325		pF
C <sub>rss</sub>	Reverse Transfer Capacitance	f = 1.0 MHz		150		pF
R <sub>G</sub>	Gate Resistance	V <sub>GS</sub> = 15 mV, f = 1.0 MHz		1.5		pF
Switchin	g Characteristics (Note 2)					
t <sub>d(on)</sub>	Turn-On Delay Time			10	19	ns
t <sub>r</sub>	Turn-On Rise Time	$V_{DD} = 15 \text{ V}, \qquad I_D = 1 \text{ A},$		7	13	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$		29	46	ns
t <sub>f</sub>	Turn-Off Fall Time			12	21	ns
Qg	Total Gate Charge			13	28	nC
Q <sub>gs</sub>	Gate-Source Charge	$V_{DS} = 15V$ , $I_{D} = 12 A$ , $V_{GS} = 5 V$		3.5		nC
Q <sub>qd</sub>	Gate-Drain Charge	] *G5 - O *		5.1		nC

#### **Electrical Characteristics** $T_A = 25$ °C unless otherwise noted Units **Symbol Parameter Test Conditions** Min Тур Max **Drain-Source Diode Characteristics and Maximum Ratings** Maximum Continuous Drain-Source Diode Forward Current 2.7 Α Drain-Source Diode Forward Voltage ٧ $V_{\text{SD}} \\$ $V_{GS} = 0 V$ , $I_S = 2.7 A$ 0.76 1.2 $I_F = 12 A$ , $d_{iF}/d_t = 100 \text{ A/}\mu\text{s}$ $t_{\text{rr}} \\$ Diode Reverse Recovery Time 24 nS $Q_{rr}$ Diode Reverse Recovery Charge 13 nC

#### Notes:

R<sub>8JA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of
the drain pins. R<sub>8JC</sub> is guaranteed by design while R<sub>8CA</sub> is determined by the user's board design.



Scale 1:1 on letter size paper

- 2. Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%
- 3. Maximum current is calculated as:  $\sqrt{\frac{P_D}{R_{DS(ON)}}}$

where  $P_D$  is maximum power dissipation at  $T_C = 25^{\circ}C$  and  $R_{DS(on)}$  is at  $T_{J(max)}$  and  $V_{GS} = 10V$ . Package current limitation is 21A

### **Typical Characteristics**

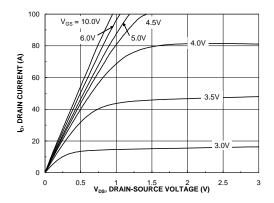


Figure 1. On-Region Characteristics

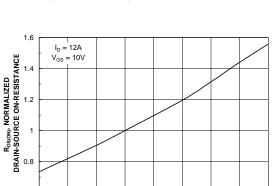


Figure 3. On-Resistance Variation withTemperature

50

 $T_J$ , JUNCTION TEMPERATURE (°C)

75

100

125

150

25

0.6

-50

-25

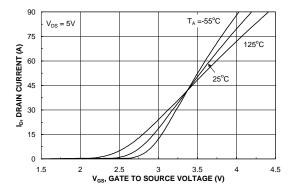


Figure 5. Transfer Characteristics

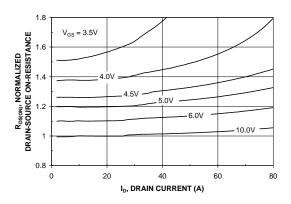


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage

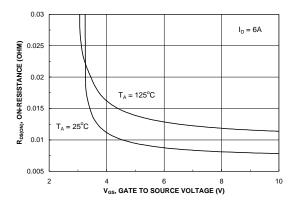


Figure 4. On-Resistance Variation with Gate-to-Source Voltage

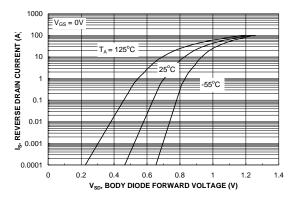
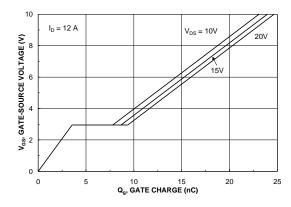


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature

### **Typical Characteristics**



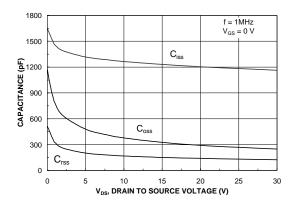
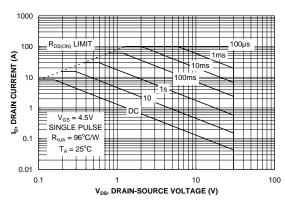


Figure 7. Gate Charge Characteristics





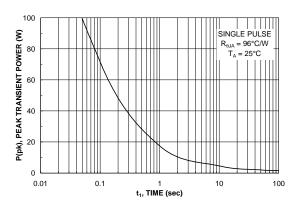


Figure 9. Maximum Safe Operating Area

Figure 10. Single Pulse Maximum Power Dissipation

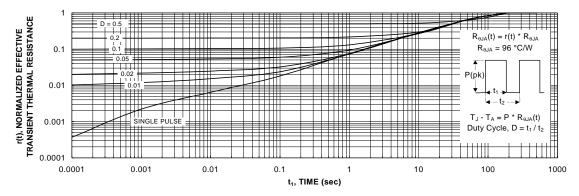
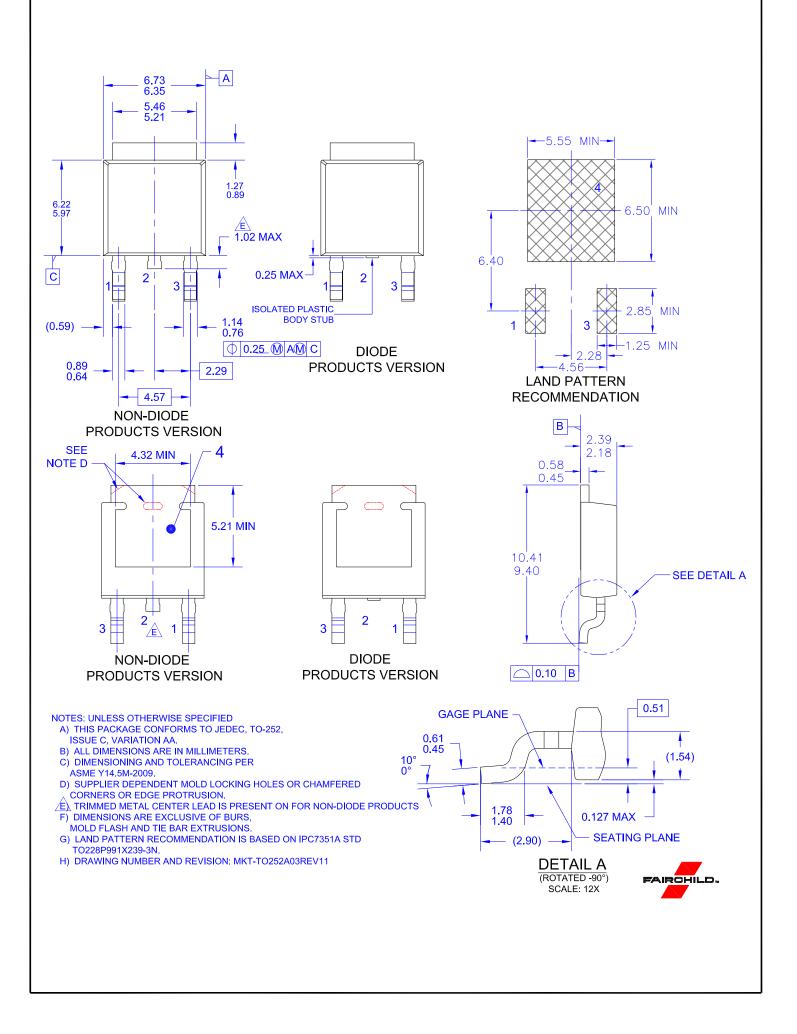


Figure 11. Transient Thermal Response Curve

Thermal characterization performed using the conditions described in Note 1b. Transient thermal response will change depending on the circuit board design.



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